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PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA	· ·	
	Name	Execution Date
CHI-CHING LO		03/25/2014
PO-HSIUNG LEU		03/25/2014
TZU-CHUN LIN		03/25/2014
DING-I LIU		03/25/2014
JEN-CHI CHANG		03/25/2014
HO-TA CHUANG		03/25/2014

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
Street Address:	NO. 8, LI-HSIN ROAD 6
Internal Address:	HSINCHU SCIENCE PARK
City:	HSIN-CHU
State/Country:	TAIWAN
Postal Code:	300-77

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14207468

CORRESPONDENCE DATA

Fax Number: (215)689-4905 Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail. Phone: 215-979-1000 Email: jsjiulianti@duanemorris.com DUANE MORRIS LLP (TSMC) IP DEPARTMENT Correspondent Name: Address Line 1: 30 SOUTH 17TH STREET Address Line 4: PHILADELPHIA, PENNSYLVANIA 19103-4196

ATTORNEY DOCKET NUMBER:	2012./1123/1085.01206
NAME OF SUBMITTER:	JONATHAN E. JOBE
SIGNATURE:	/Jonathan E. Jobe/
DATE SIGNED:	04/16/2014
Total Attachments: 3	

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ATTORNEY DOCKET NO.: 2012.1123/1085.01206

ASSIGNMENT AND AGREEMENT

For value received, we, Chi-Ching LO, Po-Hsiung LEU, Tzu-Chun LIN, Ding-I LIU, Jen-Chi CHANG, and Ho-Ta CHUANG, hereby transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Hsinchu Science Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to HIGH DENSITY PLASMA REACTOR WITH MULTIPLE TOP COILS, described in non-provisional application S.N. 14/207,468 filed March 12, 2014, and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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PATENT REEL: 032686 FRAME: 0270

ATTORNEY DOCKET NO.: 2012.1123/1085.01206

We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

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Dated: March 25, 2014 Chi-Ching Lo Chi-Ching LO Residence:

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Dated: March 25, 2014 Po-Hsiung LEU

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> PATENT REEL: 032686 FRAME: 0271

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PATENT REEL: 032686 FRAME: 0272

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